

Common Mode Filter

2 Line 67~120Ω 100~200mA

SIC5-HCI Series

MERITEK

FEATURE

- Operating Temperature: -40°C ~ +85°C
- Low Profile Construction Design
- Solve EMI problem for high speed differential signal transmission line
- Applications: MIPI, MHL serial interface in mobile device



PART NUMBERING SYSTEM

SIC **5** **2** **90RN** **A1** **HCI**
 (1) (2) (3) (4) (5) (6)

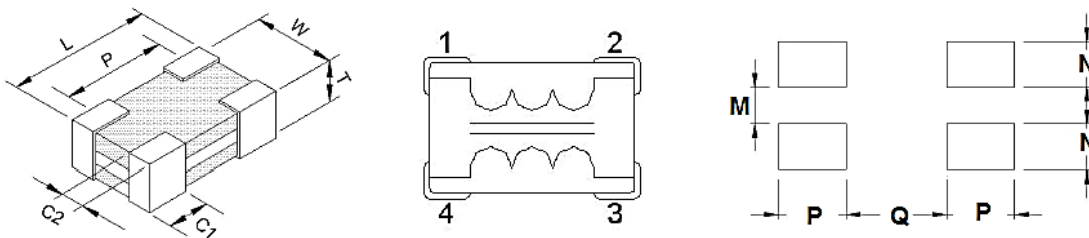


No	Item	Code	Description	Series Reference
(1)	Meritek Series	SIC	Common Mode Filter series	2 Line Low Profile Type
(2)	Dimension Code	5	5: 2.00x1.20mm	WidthxLength
(3)	Line	2	2:2 Lines	Number of Lines
(4)	Impedance/Tolerance	90RN	90RN: 90Ω ±25%	50~120Ω, -25%~ +25%
(5)	Rated Current	A1	A1:100mA	100~200mA
(6)	Internal Code	HCI	Internal Control Code	Internal or Project Reference

ELECTRICAL CHARACTERISTICS

Part Number	Impedance @100MHz (Ω)	Tolerance (%)	Max DC Resistance (Ω)	Max Rated Current (mA)	Rated Voltage (V)	Insulation Resistance (MΩ) Min.
SIC5267RNA2HCI	67	±25%	1.0	200	10	100
SIC5250RNA1HCI	50	±25%	1.0	100	10	100
SIC5290RNA2HCI	90	±25%	1.0	200	10	100
SIC52121NA1HCI	120	±25%	1.2	100	10	100

DIMENSIONS AND PCB LAND LAYOUT



Series	L ±0.20	W ±0.20	T ±0.10	P ±0.20	C1 ±0.20	C2 ±0.20	M	N	P	Q
SIC5-HCI	2.00	1.20	1.00	1.60	0.40	0.30	0.4	0.5	0.75	1.1

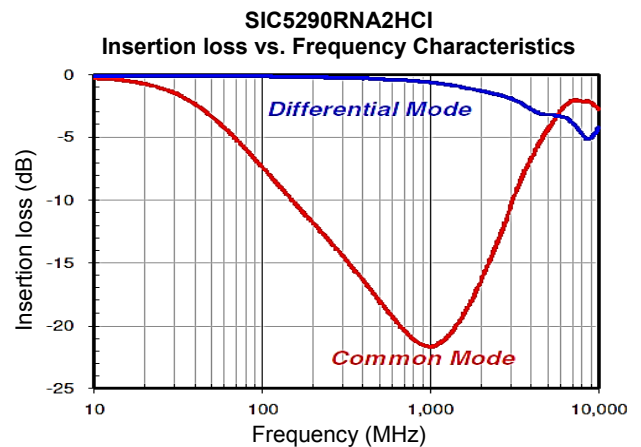
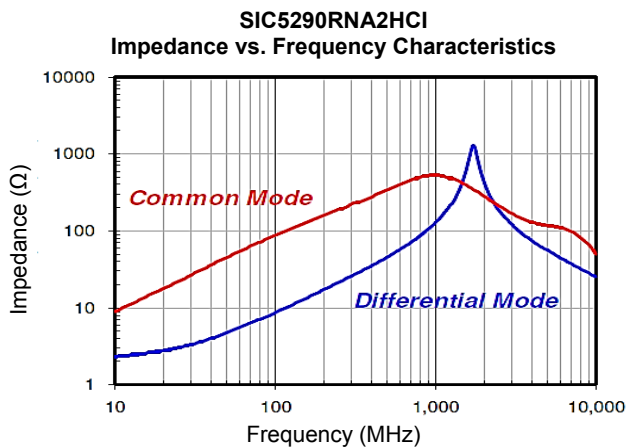
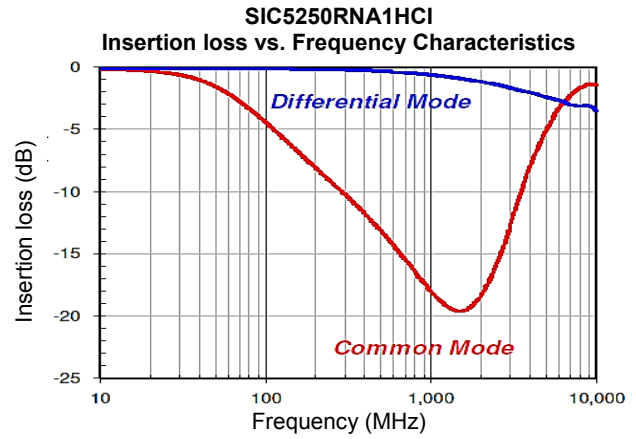
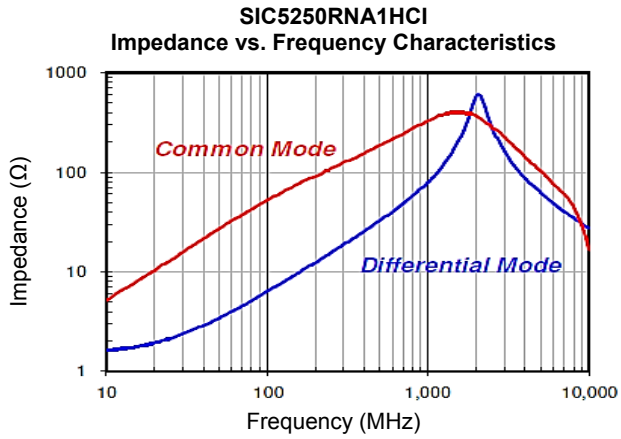
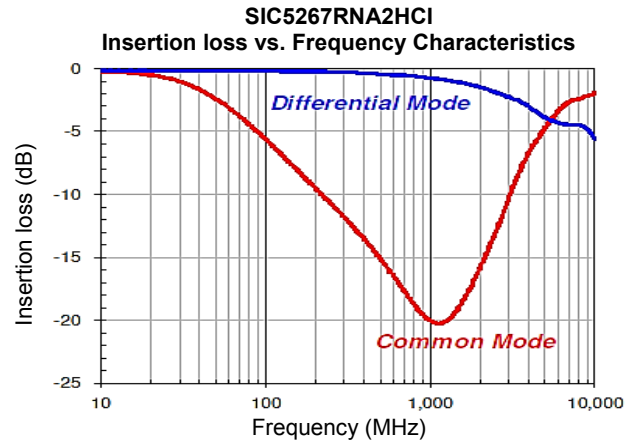
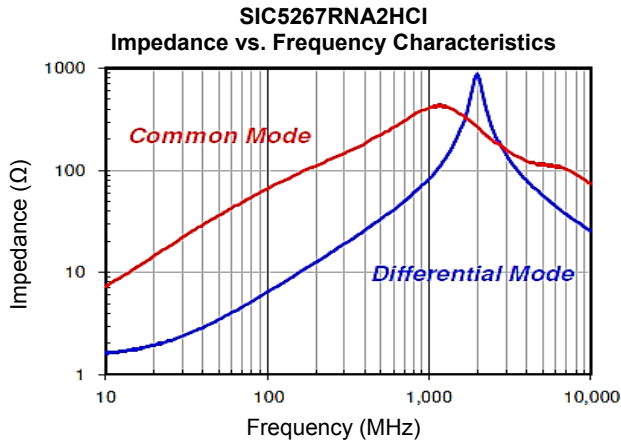
Unit: mm

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CHARACTERISTIC CURVES



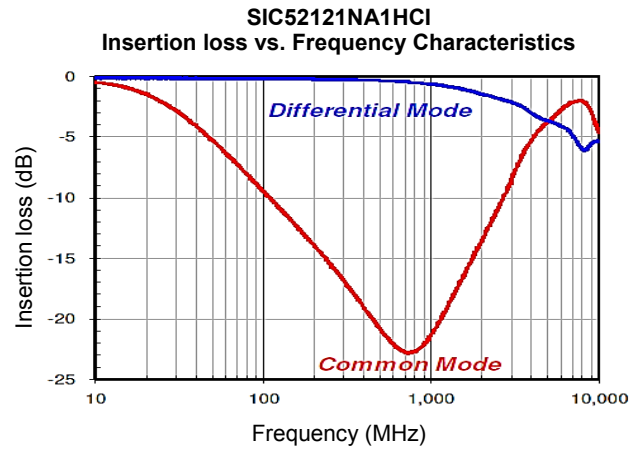
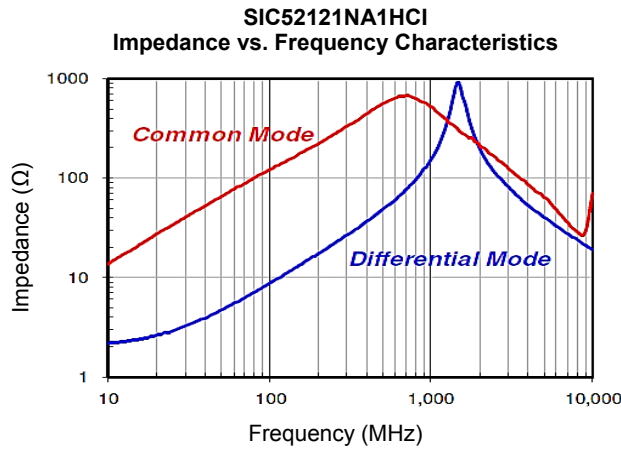
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CHARACTERISTIC CURVES



RELIABILITY TEST CONDITION AND REQUIREMENT

Test	Test Condition	Requirement
Temperature Cycle	Temperature: -40~+85°C, Cycle: 100 cycles Dwell time: 30 minutes Measurement: at ambient temperature 24 hrs after test completion	No mechanical damage Impedance value should be within ±20% of the initial value
Operational Life	Temperature: 85±5°C, Test time: 1000 hrs Apply current: full rated current Measurement: at ambient temperature 24 hrs after test completion	No mechanical damage Impedance value should be within ±20% of the initial value
Biased Humidity	Temperature: 40±2°C, Humidity: 90~95% RH Test time: 1000 hrs, Apply current: full rated current Measurement: at ambient temperature 24 hrs after test completion	No mechanical damage Impedance value should be within ±20% of the initial value
Resistance to Soldering Heat	Solder temperature: 260±5°C Flux: Rosin DIP time: 10±1 sec	More than 95% of terminal electrode should be covered with new solder No mechanical damage Impedance value should be within ±20% of the initial value
Steam Aging Test	Temperature: 93±2°C, Test time: 4 hrs Solder temperature: 235±5°C Flux: Rosin, DIP time: 5±1 sec	More than 95% of terminal electrode should be covered with new solder

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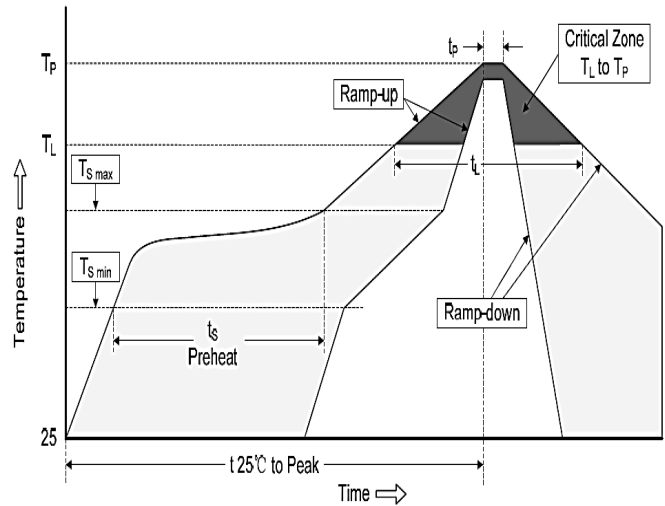
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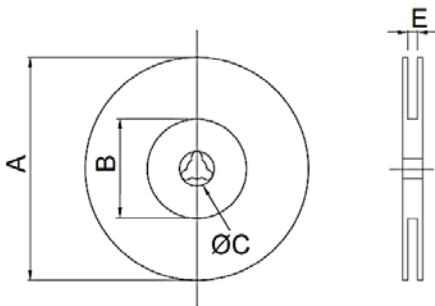
RECOMMENDED SOLDERING PROFILES

Reflow Condition		
Pre Heat	Temp. Min $T_{s(min)}$	150°C
	Temp. Max $T_{s(max)}$	200°C
	Time (min. to max.) (t_s)	60~120 seconds
Average ramp up rate (T_L) to peak		3°C/second Max.
$T_{s(max)}$ to T_L (Ramp-up rate)		3°C/second Max.
Reflow	Temp. (T_L)	217°C Min.
	Time (min. to max.) (t_L)	60~150 seconds
Peak Temperature (T_P)		255~260°C
Time within 5°C of actual peak Temperature (t_p)		≥30 seconds
Ramp-down Rate		4°C/second Max.
Time (25°C to Peak Temp.)		6 mins Max.

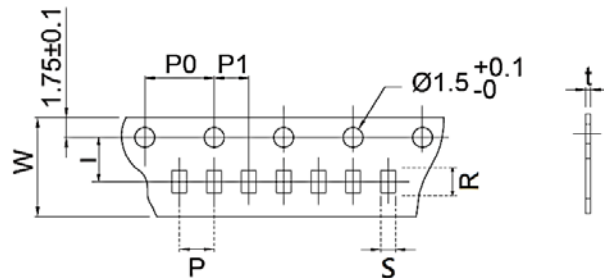


PACKAGING SPECIFICATION

CARRIER TAPE REELS



TAPE DIMENSION (mm)



Series	Reel Dimension (mm)				Tape Dimensions (mm)					Parts Per Reel
	A ±1.0	B ±0.5	C ±0.2	E ±0.5	W ±0.10	P ±0.10	P0 ±0.10	P1 ±0.10	t ±0.05	
SIC4-HCI	178.0	60.0	13.0	9.0	8.00	4.00	4.00	2.00	0.60	4,000
SIC5-HCI	178.0	60.0	13.0	9.0	8.00	4.00	4.00	2.00	0.22	3,000

*Specifications subject to change without notice.